









IC Taiwan Grand Challenge





Leveraging the Strengths of Silicon Island to Attract International Talents and Investment to Taiwan

- Combine Generative Al and Chips to drive industry-wide innovation
- Facilitate local professional development and attract Global R&D Talents
- Accelerate Heterogeneous Integration and Advanced Technology

Areas of Focus





- Startups, legal entities, academic research teams, and persons that plan to collaborate with Taiwan's semiconductor chip design and manufacturing industry.
- Proposals should include core technology, challenges solved, business model, market development plan, etc.

Domain 1

Al Core Technologies and Chips

- Al chip design
- Hardware Acceleration
- Al systems
- Generative Applications
- Large language models
- Cybersecurity

Domain 2

Smart Mobility

- Electric Vehicles
- AutonomousVehicles
- Smart Cities
- Comms/Satellite
- Drone

Domain 3

Smart Manufacturing

- IntelligentManufacturing
- IC Process
- Robotics

Domain 4

Smart Medtech

- Biometrics
- SmartMonitoring
- ·e-Health

Domain 5

Sustainability

- SustainableManufacturing
- Energy Saving Innovation
- New Energy

Criteria





LOCAL CONNECTIVITY

- 1. Have a need of resources and concrete development plans in Taiwan
- 2. Offer Taiwan broader industry development
- 3. Focus on the business plans and the goals of the applicants



VALUE CREATION

- 1. Able to drive technological innovation and create social welfare
- 2. Contribute to building new industrial links or enable industrial upgrading
- 3. Capable of raising funds or creating high economic value



TECHNOLOGICAL INNOVATION

- 1. Possess innovation in emerging fields of application
- 2. Propel innovation in the manufacturing process, design, and use of new materials
- 3. Integrate diverse innovation and cross-domain knowledge



Benefits





US \$30,000



Mentorship by
Semiconductor Industry
Experts



Prototyping to Production (EDA Tools, Wafer, etc.)



Multifaceted Resources and Services to Ensure Success

 Provide key resources and expert consulting support to accelerate solution development from prototyping to production through the startup acceleration platform

- Upon team arrival in Taiwan
- In person exhibition of innovation
- * details to follow

IC Startup Acceleration Platform





Taiwan

Gold Card

Connecting the Semiconductor Supply Chain Players

Execution

- One-stop services to support startups in linking to necessary resources in Taiwan.
- Accelerating product development and fostering innovation through Taiwan's semiconductor expertise and resources.

IC Design Flow

IP **Architecture** Licensing

IC Design /EDA Service **Package Testing Service**

Shuttle Service

PCB/ **System Service**

Resource Matching



One-Stop

shopping

EDA tools **KEYSIGHT** SYNOPSYS

cādence









Competition Timeline



November 1st, 2025

Online Application Open



*Winning teams will attend award ceremony and exhibit at COMPUTEX/ InnoVEX held on June 2nd-5th in Taiwan

TIMELINE



Online Application Deadline



1st Batch of Winners (Announced in August 2024)



UNITED KINGDOM

UNITED STATES

TAIWAN

UNITED STATES

TAIWAN

SMART DATA & AI



ULTRA-EFFICIENT REVOLUTIONARY QUANTUM POWERED UNIVERSAL COMPUTER

Quinas Technology (ULTRARAM)

7

Pioneers a breakthrough memory that merges the speed of DRAM with the non-volatility of flash, enabling next-gen storage. **SMART MOBILITY**

GALAVERSE

LARGE BANDWIDTH, LOW LATENCY, AND COMPLEMENTARY DEPLOYMENT, HIGH FREQUENCY RADIO TECHNOLOGIES

GalaVerse USA

Leverages high-frequency radio to power low-latency, high-bandwidth connectivity for the future of ubiquitous computing.

SMART MOBILITY

Ranictek

IC DESIGN, 5G/6G BASE STATION CHIPS, SATELLITE COMMUNICATION CHIPS

Ranictek Inc.

Develops cost-effective, energy-saving baseband chips to accelerate 5G/6G and satellite communication deployments.

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SUSTAINABILITY



EMPOWERING INTEGRATED PHOTONICS FOR COMMUNICATIONS AND COMPUTATION

Polaris Electro-**Optics**

Delivers industry-leading high-speed, energy-efficient photonics through patented materials and design innovations.

SUSTAINABILITY



WIRELESS POWER · WIRELESS FREEDOM

Voltraware Semiconductor Co. Ltd.

Enables multi-device, longrange wireless charging with advanced magnetic resonance ICs for e-mobility and consumer electronics.

2nd Batch of Winners (Announced in April 2025)



SINGAPORE

SMART DATA & AI



#AI大語言模型、#高效記憶體、#生成

TurboNext.ai

Scales large language model performance with heterogeneous compute and high-memory Al accelerators.

SINGAPORE

SMART DATA & AI



#後量子密碼學、#資安韌性、#PUF、 #硬體安全晶片

JMEM TEK HOLDING CO PTE. LTD.

Provides post-quantum, uncrackable chip-level security through innovative semiconductor IP and hardware design.

UNITED KINGDOM

SMART MEDTECH



#基因電路工程技術、#器官晶片 #OOC(ORGAN-ON-A-CHIP)

Genenet Technology (UK) Limited

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Revolutionizing preclinical drug discovery with an Aland quantum-powered multi-organoid-on-chip platform for streamlined drug screening.

FRANCE

SUSTAINABILITY



#氦化鎵電源元件、#大幅提高功率密度

WISE-**INTEGRATION**

Enabling ultra-compact, high-efficiency AC-DC power supplies with integrated GaN power ICs and proprietary digital controllers.

SWEDEN

SUSTAINABILITY



#奈米純水解決方案、#提升半導體良率、#永續發展

NSS Water

Transforming semiconductor industry with cutting-edge nanopure water technology for a cleaner, sustainable future.

7

2nd Batch of Winners (Announced in April 2025)



SINGAPORE

SINGAPORE

UNITED KINGDOM

FRANCE

SWEDEN

SMART DATA & AI

SMART DATA & AI

SMART MEDTECH

SUSTAINABILITY

SUSTAINABILITY



JMEMTEK



> NSS WATER

TurboNext.Al

JMEMTEK

Genenet **Technology**

WISE-**INTEGRATION** **NSS Water**

Scales large language model performance with heterogeneous compute and high-memory AI accelerators.

Provides post-quantum, uncrackable chip-level security through innovative semiconductor IP and hardware design.

Revolutionizing preclinical drug discovery with an Aland quantum-powered multi-organoid-on-chip platform for streamlined drug screening.

Enabling ultra-compact, high-efficiency AC-DC power supplies with integrated GaN power ICs and proprietary digital controllers.

Transforming semiconductor industry with cutting-edge nanopure water technology for a cleaner, sustainable future.

3rd Batch of Winners (Announced in August 2025)



UNITED STATES

AI CORE TECHNOLOGIES
AND CHIPS



femtoAl

femtoAI brings intelligence to everyday devices with our Embedded AI Platform: an ultra-efficient AI accelerator, end-to-end software stack, and production-grade AI models. REPUBLIC OF KOREA

AI CORE TECHNOLOGIES
AND CHIPS

HYPER ACCEL

HyperAccel

HyperAccel creates semiconductors and solutions for Generative AI, empowering a world where advanced technology is accessible and beneficial to all. **TAIWAN**

AI CORE TECHNOLOGIES
AND CHIPS

DeepMentor

DeepMentor Inc. 滿拓科技

Transforming AI from software to silicon.
DeepMentor miniaturizes and hardens AI models into efficient chips for secure, real-time, edge intelligence.

SWEDEN

SMART MANUFACTURING

♦ AlixLabs

AlixLabs AB

APS, a disruptive and sustainable method for advancing semiconductor scaling — reducing cost, energy consumption, CO₂ emissions, and water usage.

3rd Batch of Winners (Announced in August 2025)



TAIWAN

SMART MOBILITY



Brilliant Silicon Technology Co., Ltd.

錡曄電子有限公司

Brilliant Silicon (BSi), is a leading IC design company that has connected millions of devices on Earth through Bluetooth and IoT technologies.

TAIWAN

SMART MEDTECH



EndoSemio Co., Ltd. 安德斯醫學科技

EndoSemio is a medtech startup developing imaging platform across single-use micro endoscopes. UNITED STATES

SUSTAINABILITY

3D Architech

3D Architech, Inc.

3D Architech is a Caltech spin-out pioneering 10micron resolution metal 3D printing for advanced cooling and energy components. **DENMARK**

SUSTAINABILITY



PurCity ApS

PurCity's patented GapS facade panels revolutionize buildings. It is integrated with AI/ML to ensure peak performance.



IC TAIWAN GRAND CHALLENGE







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